

DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS Safety Certification: NPO/X7R (Pb Free & RoHS compliant)

X1/Y2 AND X2/Y3 2.2 pF to 4.7 nF





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Surface-Mount Ceramic Multilayer Capacitors Safety Certification NP0/X7R X1/Y2 & X2/Y3

<u>SCOPE</u>

This specification describes safety certification NP0/X7R series chip capacitors with lead-free terminations.

APPLICATIONS

- PCs, Notebook
- Networking
- Power supplies
- Automotive

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- <u>FEATURES</u>
- Supplied in tape on reel
- Nickel-barrier end termination

ORDERING INFORMATION - 12NC & CLEAR TEXT CODE

Part numbers below are identified by the series, size, tolerance, packing style, TC material, rated voltage and capacitance value. Both 12NC or CTC code are acceptable to be used as Phycomp brand.

YAGEO BRAND ordering codes

CTC CODE

SC	<u>XXXX</u>	<u>x x</u>	<u>XXX</u>	<u>x</u> B	<u>X</u>	<u>XXX</u>
	(1)	(2) (3)	(4)	(5)	(6)	(7)

(I) SIZE - INCH BASED (METRIC)

1808 (4520)

1812 (4532)

(2) TOLERANCE

 $B = \pm 0.1 \text{ pF}$ $C = \pm 0.25 \text{ pF}$ $D = \pm 0.5 \text{ pF}$ $F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$ $K = \pm 10\%$ $M = \pm 20\%$

(3) PACKING STYLE

K = Embossed Plastic Tape; Reel 7 inch

(4) TC MATERIAL

NP0 X7R

(5) SAFETY RATED VOLTAGE

T = X2/Y3 for TUVW = X1/Y2 for TUVU = X2/Y3 for ULV = X1/Y2 for UL

(6) PROCESS

B = BME

N = Non BME

(7) CAPACITANCE VALUE

First two for significant figures and 3rd for number of zero. Letter "R" for decimal point



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PHYCOMP BRAND ordering codes

12NC CODE



(2) Quantity on reel depends on thickness classification; see section "Thickness classification and packing quantities for safety certification MLCC

Conversion table of capacitance & last 2 digits of 12NC

CAP. (pF)	Last 2 digits of I2NC												
2.2	18	12	24	33	29	82	35	220	41	560	46	1500	52
3.3	19	15	25	39	31	100	36	270	42	680	47	1800	53
4.7	21	18	26	47	32	120	37	330	43	820	48	2200	54
5	22	22	27	56	33	150	38	390	44	1000	49	3300	56
10	23	27	28	68	34	180	39	470	45	1200	51	4700	58

CTC CODE (FOR NORTH AMERICA ONLY)

U Example: 1808CG101JTBB1S

1808	CG	101	J	Т	В	В	I	S
Size code	Temp. Char.	Capacitance in pF	Tolerance	Safety rated voltage	Termination	Packing	Marking	Range identifier
1808	CG = NP0 2R = X7R	101 = 100 pF; the third digit signifies the multiplying factor: $0 = \times 1$ $1 = \times 10$ $2 = \times 100$ $3 = \times 1,000$	$B = \pm 0.1 \text{ pF}$ $C = \pm 0.25 \text{ pF}$ $D = \pm 0.5 \text{ pF}$ $F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$ $K = \pm 10\%$ $M = \pm 20\%$	T = X2/Y3 for TUV W = X1/Y2 for TUV U = X2/Y3 for UL V = X1/Y2 for UL	B = NiSn	B = 180 mm; 7'' blister	I = marking 0= no marking	S = Safety certification



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Product specification

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CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.







Table I						
TYPE			SC1808	SC1812		
L _I (mm)			4.5 ±0.30	4.5 ±0.30		
W (mm)			2.0 ±0.30	3.2 ±0.30		
T (mm)			R	Refer to table 2 to 4		
L ₂ /L ₃ (mm) 1	min.		0.25	0.25		
L ₂ /L ₃ (mm) 1	max.		0.75	0.75		
L₄ (mm)	min.	XI/Y2(TUV)	4.00	4.00		
		X2/Y2 (TUV)	2.20	2.20		
		UL	2.20	2.20		

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Table 2 For NP	0 X1/Y2 and X2/Y3 siz	es from 1808 to 1812			
CAPACITANCE		1808, X1/Y2		1812, XI/Y2	1812, X2/Y3
(pF)	TUV	UL	TUV	UL	TUV
2.2					
3.3					
4.7					
5					
10					
12					
15					
18					
22		1.6±0.2	1.6±0.2	1.6±0.2	
27	I.6±0.2				
33					
39					
47					1.15±0.15
56					
68					
82					
100					
120					
150					
180				2.0±0.2	
220		2.0±0.2			
270	2.0±0.2		2.0±0.2		
330					
390					
470					

CAPACITANCE RANGE & THICKNESS FOR NPO XI/Y2 AND X2/Y3

NOTE

- I. Values in shaded cells indicate thickness class in mm.
- 2. Capacitance range < 10 pF is on request.
- 3. Capacitance value of non E-12 series is on request.



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CAPACITANCE RANGE & THICKNESS FOR X7R XI/Y2 AND X2/Y3

Table 3 For X7	'R XI/Y2 and X	2/Y3 sizes from	1808 to 1812				
CAPACITANCE		1808, X1/Y2		1808, X2/Y3		1812, X1/Y2	1812, X2/Y3
(PF)	TUV	UL	TUV	UL	TUV	UL	TUV
150							
180	1.6±0.2	1.6±0.2					
220							
270					1.6±0.2	1.6±0.2	
330							
390							
470							
560	2.0±0.2	2.0±0.2					
680						20102	
820			1.35±0.15		2.0±0.2	2.0±0.2	
1,000							
I,200				20+02			
1,500				2.0±0.2			
1,800							1.35±0.15
2,200							
3,300							
4,700							

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2. Capacitance value of non E-12 series is on request.

THICKNESS CLASSES AND PACKING QUANTITY

-	Tab	le	4
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DESCRIPTION	SIZE CODE	THICKNESS CLASSIFICATION (mm)	12 mm TAPE WIDTH /AMOUNT PER REEL Ø180 mm, 7" Blister
	1808	1.15 ±0.15	١,500
		1.35 ±0.15	١,000
		1.6 ±0.20	2,000
Contification		2.0 ±0.20	2,000
Capacitor	1812	1.15 ±0.15	1,500
		1.35 ±0.15	1,000
		I.6 ±0.20	1,000
		2.0 ±0.20	2,000



I. Values in shaded cells indicate thickness class in mm.

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ELECTRICAL CHARACTERISTICS

NP0/X7R DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise stated all electrical values apply at an ambient temperature of 20±1 °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

Table 5	
DESCRIPTION	VALUE
Capacitance range ⁽¹⁾	2.2 pF to 4.7 nF
Capacitance tolerance ⁽¹⁾	±5% and ±10%
Dissipation factor (D.F.) ⁽¹⁾	
NP0	≤ 0.1%
X7R	≤ 2.5%
Insulation resistance after 1 minute at U _r (DC)	$R_{ins} \geq$ 10 GQ or $R_{ins} \times$ C \geq 500 seconds whichever is less
Maximum capacitance change as a function of temperature	
(temperature characteristic/coefficient):	
NP0	±30 ppm/ C
X7R	±15%
Operating temperature range:	
NP0/X7R	–55 °C to +125 °C
	NP0: 55/125/21
Climatic category (EN 132400)	X7R: 55/125/56

NOTE

1. NP0: frequency = 1 MHz for C \leq 1 nF, measuring at voltage 1 Vrms; frequency = 1 KHz for C > 1 nF, measuring at voltage 1 Vrms; X7R: frequency = 1 KHz for C \leq 10 μ F, measuring at voltage 1 V_{rms}

Soldering recommendation

Table 6					
SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	\geq 0.1 µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1 µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	



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TESTS AND REQUIREMENTS

Table 7 Test condition, procedure and requirements

TEST	TEST MET	HOD	PROCEDURE	REQUIREMENTS
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage
Visual inspection and dimension check		4.4	Any applicable method using × 10 magnification	In accordance with specification
Capacitance		4.5.1	NP0: $f = I$ MHz for C $\leq I$ nF, measuring at voltage I V _{rms} at 20 °C; $f = I$ KHz for C $\geq I$ nF, measuring at voltage I V _{rms} at 20 °C X7R: $f = I$ KHz for C $\leq I0$ µF, measuring at voltage I V _{rms} at 20 °C	Within specified tolerance
Dissipation factor (D.F.)		4.5.2	NP0: $f = 1$ MHz for C ≤ 1 nF, measuring at voltage 1 V _{rms} at 20 °C; f = 1 KHz for C > 1 nF, measuring at voltage 1 V _{rms} at 20 °C X7R: $f = 1$ KHz for C ≤ 10 µF, measuring at voltage 1 V _{rms} at 20 °C	In accordance with specification
Insulation resistance		4.5.3	At U _r (DC) for I minute	In accordance with specification
Temperature characteristic		4.6	Between minimum and maximum temperature	NP0: ΙΔC/CI: 30 ppm/°C X7R: ΙΔC/CI: 15%
Adhesion		4.15	 a. A force applied for 10 sec to the line joining the terminations and in a plane parallel to the substrate for size ≥ 0603 : a force of 5N applied b. A force applied until broken For size≥ 0603: ≥ 5N 	No visible damage



TEST		IOD	PROCEDURE	REQUIREMENTS
Bond strength of plating on	IEC 60384- 21/22	4.8	Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage
end face			Conditions: bending 1 mm at a rate of 1 mm/s, radius jig 340 mm	NP0: $ \Delta C/C \le 1\%$ or 0.5 pF whichever is greater X7R: $ \Delta C/C \le 10\%$
Resistance to soldering heat		4.9	Precondition: 150 +0/–10 °C for 1 hour, then keep for 24 \pm 1 hours at room temperature	The termination shall be well tinned
			Preheating: for size \leq 1206: 120 to 150 °C for 1 minute	NP0: I∆C/CI: ≤ 0.5% or 0.5 pF whichever is greater
			Preheating: for size >1206: 100 to 120 °C for 1	X7R: $ \Delta C/C \le 10\%$
			minute and 170 to 200 °C for 1 minute Solder bath temperature: 260 \pm 5 °C	D.F.: within initial specified value
			Dipping time: 10 \pm 0.5 seconds	R _{ins} : within initial specified value
			Recovery time: 24 ±2 hours.	
Solderability		4.10	Unmounted chips completely immersed in a solder bath at 235 \pm 5 °C Dipping time: 2 \pm 0.5 seconds	The termination shall be well tinned.
			Depth of immersion: 10 mm	
Rapid change of temperature		4.11	Preconditioning; 150 +0/–10 °C for 1 hour, then keep for 24 ±1 hours at room temperature	No visual damage NP0: I∆C/CI: ≤ 1% or 1 pF whichever is greater
			5 cycles with following detail:30 minutes at lower category temperature;30 minutes at upper category temperature	X7R: $ \Delta C/C \le 15\%$ D.F.: within initial specified value R _{ins} : within initial specified value
			Recovery time 24 \pm 2 hours.	
Damp heat, with U _r load		4.13	Initial measurements; after $150 \pm 0/-10$ °C for 1 hour, then keep for 24 ± 1 hours at room temperature Duration and conditions: 500 ± 12 hours at 40 ± 2 °C; 90 to 95% RH: U _c applied	NP0: $ \Delta C/C $: $\leq 2\%$ or $ $ pF whichever is greater X7R: $ \Delta C/C $: $\leq 5\%$
		Final measurement: perform a heat treatment at $150 + 0/-10$ °C for 1 hour, final measurements shall be carried out 24 ±1 hours after recovery at room temperature without load.	NP0: D.F.: 2 × initial value max. $\times 7R \ge 100 \forall : D.F. \le 5\%$ NP0: $R_{ins} \ge 2,500 \text{ M}\Omega \text{ or } R_{ins} \times C_r \ge 25 \text{ seconds}$, whichever is less $\times 7R: R_{ins} \ge 500 \text{ M}\Omega \text{ or } R_{ins} \times C_r$ $\ge 25 \text{ seconds}$, whichever is less	

Table 7	Test condition,	procedure and	requirements ((continued)	

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TEST	TEST METHOD		PROCEDURE	REQUIREMENTS	
Endurance	EN I 32400	4.14 SC	Perform shear test, substrate bending test, impulse voltage and then endurance test progressively.	Visual examination	
			Same as the above except for 1.25 UR for X- capacitor and 1.7 UR for Y-capacitor.	DC/C < ± 20%	
			Once every hour the voltage shall be increased to 1000VAC for 0.1 s.	Voltage proof	
			Total time take to change over to 1000 VAC and back does not exceed 30 s.	$IR > 3 \times 10E9 \Omega$	
Impulse Voltage		4.13 SC	X I: 4.0k VDC, X2: 2.5k VDC, X3: 1.2k VDC YI: 8.0k VDC, Y2: 5.0k VDC, Y3: None, Y4: 2.5k VDC Apply 3 successive impulses. Time between impulses shall not be less than 10 s.	No breakdown or flashover	
Robustness of Termination		4.3 SC	a. A force applied for 10 sec to the line joining the terminations and in a plane parallel to the substrate.	a. No visible damage	
(Pull Strength)			b. A force applied until broken	b. Force size \geq 0603: \geq 5N size = 0402: \geq 2.5N size = 0201: \geq 1N	
Voltage proof		4.2.1 SC	C For X1, X2 and X3: 4.3Ur (1.075k VDC) No breakdown or fl For Y1: 4k VAC For Y2 and Y3: 1.5k VAC For Y4: 900 VAC		

Table 7 Test condition, procedure and requirements (continued)



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<u>REVISION HISTORY</u>					
REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION		
Version 0	Mar I, 2007	-	- New		

